#### PATENT ASSIGNMENT

## Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Keng Hung Lin	08/19/2011

#### **RECEIVING PARTY DATA**

Name:	Advanced Analogic Technologies (Hong Kong) Limited
Street Address:	No. 1 Science Museum Road
Internal Address:	Unit 12, 17/F North Tower
City:	Hong Kong
State/Country:	CHINA

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13210841

#### **CORRESPONDENCE DATA**

Fax Number: (408)521-0604

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 6089355300

Email: dsteuber@patentabilityassoc.com

Correspondent Name: David E. Steuber
Address Line 1: 1581 County Road W

Address Line 4: Mineral Point, WISCONSIN 53565

ATTORNEY DOCKET NUMBER: AATI-35-DS-US

NAME OF SUBMITTER: David E. Steuber

Total Attachments: 1

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OF \$40.00 132108

PATENT REEL: 026778 FRAME: 0990

Attorney Docket No.: AATI-35-DS-US

### **ASSIGNMENT**

For good and valuable consideration, receipt of which is hereby acknowledged, I:

Keng Hung Lin, of No. 25, Lane 9, Sinjang Rd., Gushan District, Kaohsiung, 804 Taiwan;

hereby sell, assign and transfer to Advanced Analogic Technologies (Hong Kong) Limited, a corporation of Hong Kong, its successors and assigns, the entire right, title and interest throughout the world in my invention in

# MULTI-DIE SEMICONDUCTOR PACKAGE WITH ONE OR MORE EMBEDDED DIE PADS

for which I have executed a United States patent application on July 29, 2011, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the abovenamed assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 1 day of 4 4 2 2 2011.

Keng Hung Lin

PATENT REEL: 026778 FRAME: 0991

RECORDED: 08/19/2011